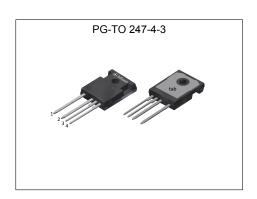


MOSFET

650V CoolMOS™ CFD7 SJ Power Device

The latest 650 V CoolMOS™ CFD7 extends the voltage class offering of the CFD7 family and is a successor to the 650 V CoolMOS™ CFD2. Resulting from improved switching performance and excellent thermal behavior, 650 V CooMOS™ CFD7 offers highest efficiency in resonant switching topologies, such as LLC and phase-shift-full-bridge (ZVS). As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness. The CoolMOS™ CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions.



Features

- · Ultra-fast body diode
- 650V break down voltage
- Best-in-class R_{DS(on)}
- · Reduced switching losses
- Low R_{DS(on)} dependency over temperature

Benefits

- · Excellent hard commutation ruggedness
- Extra safety margin for designs with increased bus voltage
- Enabling increased power density solutions
- Outstanding light load efficiency in industrial SMPS applications
- Improved full load efficiency in industrial SMPS applications
- Price competitiveness over previous CoolMOS™ families

Potential applications

Suitable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging, Solar



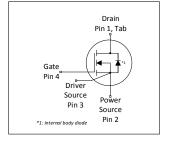
Fully qualified according to JEDEC for Industrial Applications

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate.



Parameter	Value	Unit
V _{DS} @ T _{j,max}	700	V
R _{DS(on),max}	29	mΩ
$Q_{g,typ}$	145	nC
I _{D,pulse}	304	A
E _{oss} @ 400V	19.8	μJ
Body diode di _F /dt	1300	A/µs

Type / Ordering Code	Package	Marking	Related Links
IPZA65R029CFD7	PG-TO247-4-3	65R029F7	see Appendix A









650V CoolMOS™ CFD7 SJ Power Device IPZA65R029CFD7



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650V CoolMOS™ CFD7 SJ Power Device IPZA65R029CFD7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Ols al		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	69 44	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	304	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	358	mJ	I _D =7.3A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	1.79	mJ	I _D =7.3A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	7.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	305	W	T _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current ¹⁾	Is	-	-	69	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	304	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	V_{DS} =0400V, I_{SD} <=35.8A, T_{j} =25°C see table 8	
Maximum diode commutation speed	di₅/dt	-	-	1300	A/μs	V_{DS} =0400V, I_{SD} <=35.8A, T_{j} =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch with identical R_G

650V CoolMOS™ CFD7 SJ Power Device IPZA65R029CFD7



2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Symbol	Values			11	Nata / Tank Canadikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.41	°C/W	-	
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded	
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.	
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

650V CoolMOS™ CFD7 SJ Power Device IPZA65R029CFD7



Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Oh o.l		Values			Note / Took Open diding	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V_{GS} =0V, I_D =1mA	
Gate threshold voltage	V _{(GS)th}	3.5	4	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.79{\rm mA}$	
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 27	1 54	μΑ	V _{DS} =650V, V _{GS} =0V, T _j =25°C V _{DS} =650V, V _{GS} =0V, T _j =125°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.024 0.053	0.029	Ω	V _{GS} =10V, I _D =35.8A, T _j =25°C V _{GS} =10V, I _D =35.8A, T _j =150°C	
Gate resistance	R _G	-	3.8	-	Ω	f=1MHz, open drain	

Dynamic characteristics Table 5

Downwarten.	C: mah al		Values			Nata (Tant Oan dition	
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition	
Input capacitance	C _{iss}	-	7149	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	106	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ²⁾	y C _{o(er)} - 247		247	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	2584	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	t _{d(on)}	-	54	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Rise time	t _r	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Turn-off delay time $t_{ ext{d(off)}}$		-	159	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Fall time	t _f	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Parameter	Cymbal	Values			Unit	Note / Test Condition	
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	41	-	nC	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V	
Gate to drain charge	Q_{gd}	-	44	-	nC	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V	
Gate charge total	Q_g	-	145	-	nC	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V	
Gate plateau voltage	V _{plateau}	-	5.7	-	V	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V	

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

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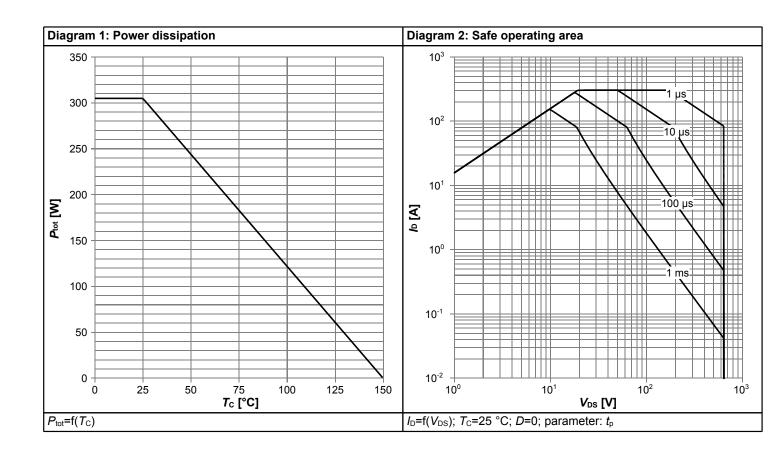


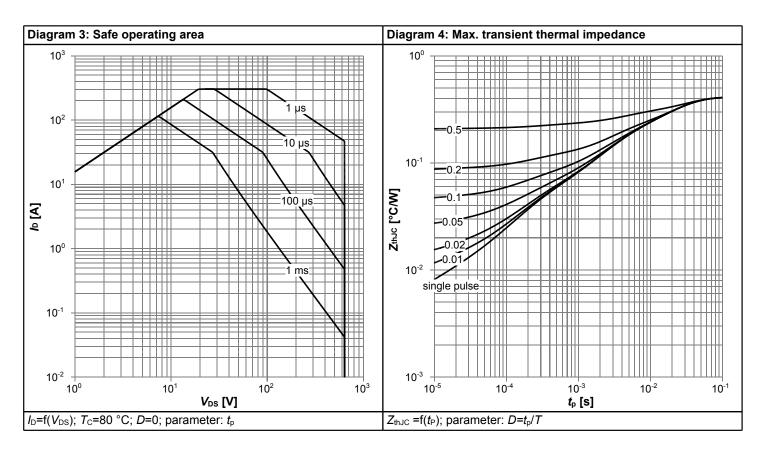
Table 7 Reverse diode characteristics

Davamatav	Cymphal	Values			11:4	Nata / Tank Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode forward voltage	V _{SD}	-	1.0	-	V	V _{GS} =0V, I _F =35.8A, T _j =25°C	
Reverse recovery time	t _{rr}	-	208	312	ns	V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8	
Reverse recovery charge	Q _{rr}	-	1.6	3.2	μC	V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	13.1	_	А	V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8	

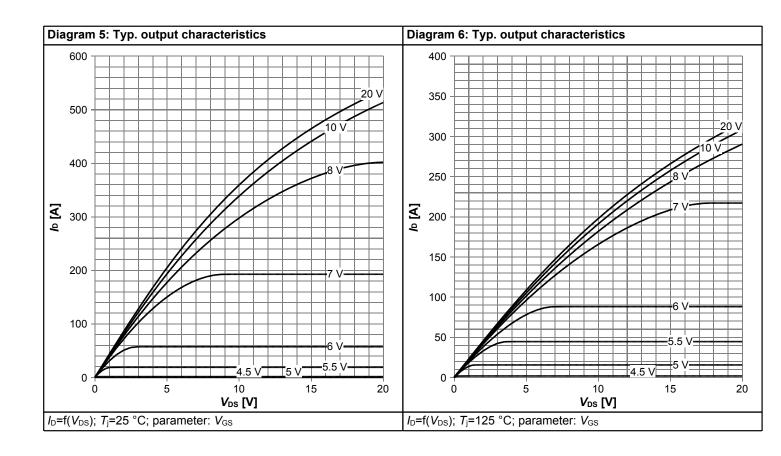


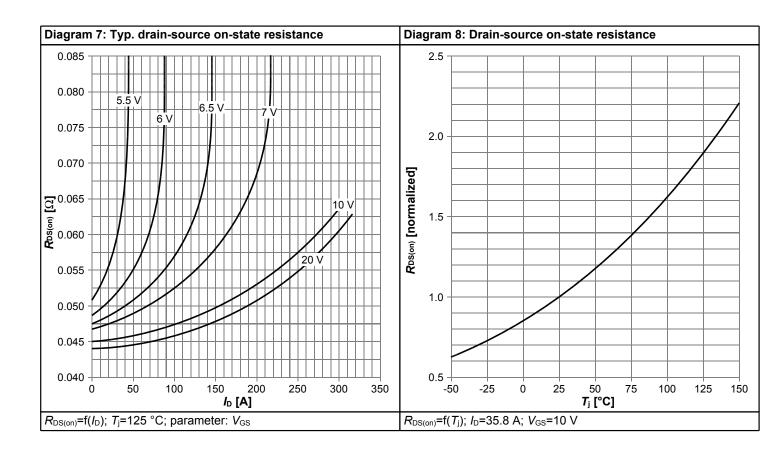
4 Electrical characteristics diagrams



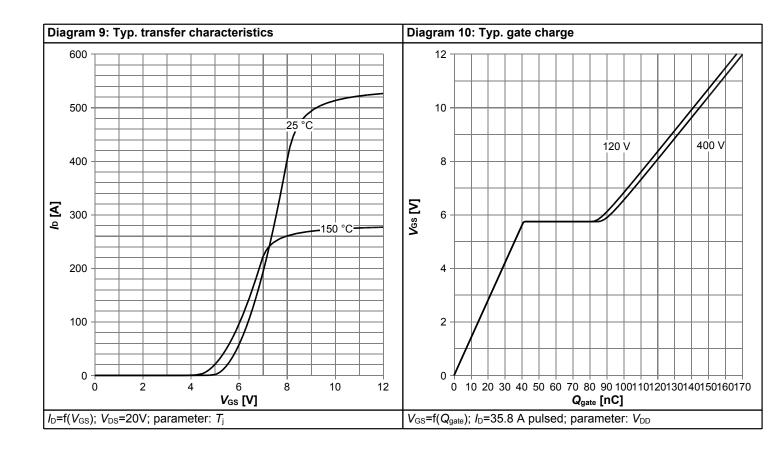


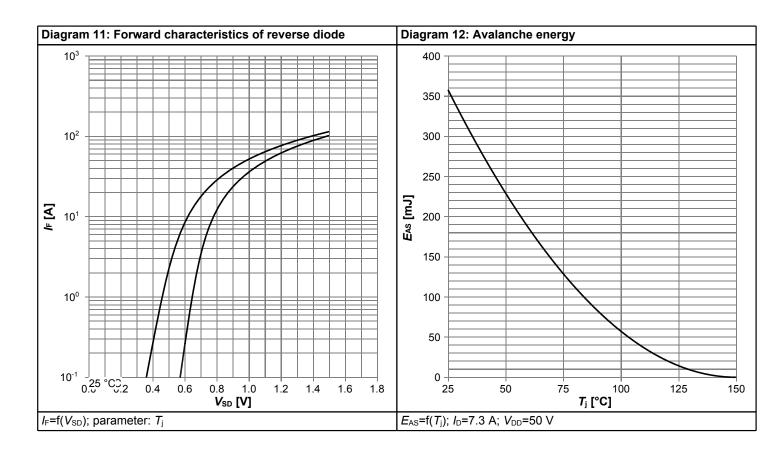




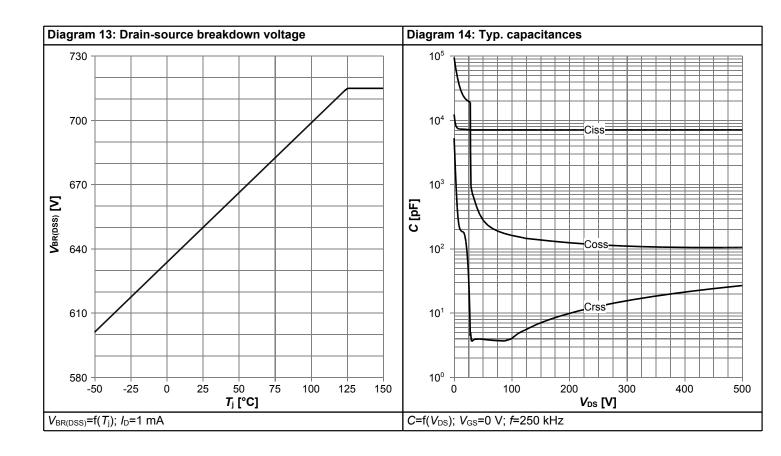


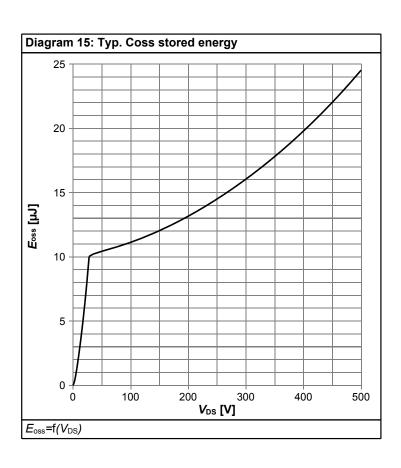














5 Test Circuits

Table 8 Diode characteristics

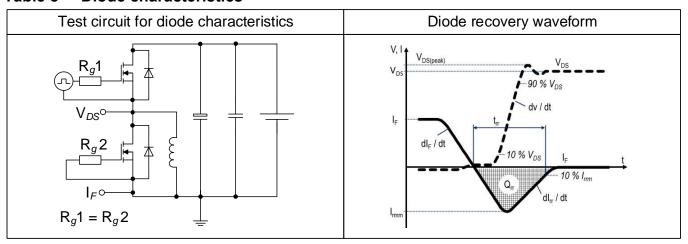


Table 9 Switching times (ss)



Table 10 Unclamped inductive load (ss)





6 Package Outlines

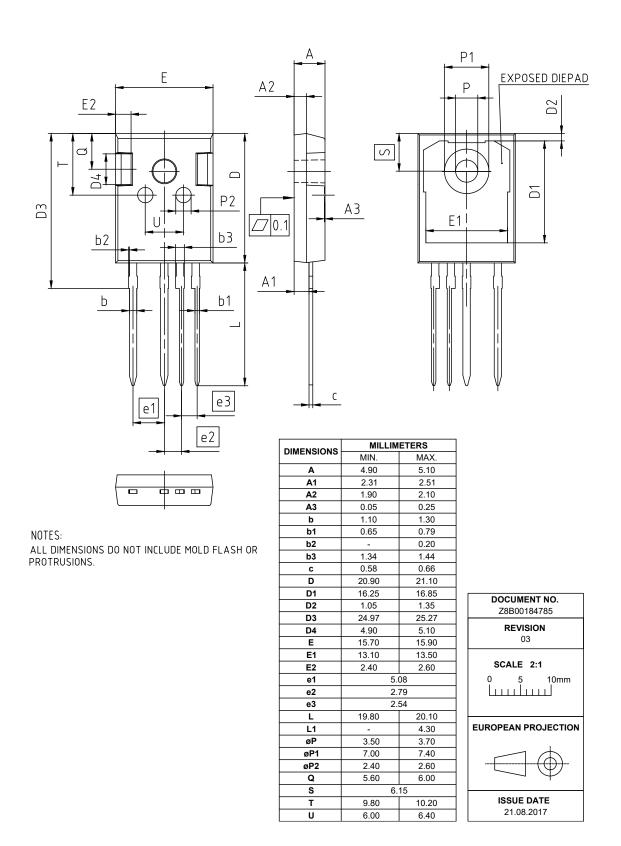


Figure 1 Outline PG-TO247-4-3, dimensions in mm

650V CoolMOS™ CFD7 SJ Power Device IPZA65R029CFD7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 650V Webpage: www.infineon.com

• IFX CoolMOS CFD7 650V application note: www.infineon.com

• IFX CoolMOS CFD7 650V simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

650V CoolMOS™ CFD7 SJ Power Device

IPZA65R029CFD7



Revision History

IPZA65R029CFD7

Revision: 2020-08-12, Rev. 2.1

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Revision	Date	Subjects (major changes since last revision)						
2.0	2020-06-29	Release of final version						
2.1	2020-08-12	Increased continuous diode forward current rating						

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Final Data Sheet 14 Rev. 2.1, 2020-08-12